Document made available under the Patent Cooperation Treaty (PCT)

International application number: PCT/SE05/000333

International filing date: 04 March 2005 (04.03.2005)

Document type: Certified copy of priority document

Document details: Country/Office: SE
Number: 0400582-3
Filing date: 05 March 2004 (05.03.2004)

Date of receipt at the International Bureau: 01 April 2005 (01.04.2005)

Remark: Priority document submitted or transmitted to the International Bureau in compliance with Rule 17.1(a) or (b)

World Intellectual Property Organization (WIPO) - Geneva, Switzerland
Organisation Mondiale de la Propriété Intellectuelle (OMPI) - Genève, Suisse

PCT / SE 2005 / 0 0 0 3 3

PRV

PATENT- OCH REGISTRERINGSVERKET
Patentavdelningen

Intyg
Certificate

Härmed intygas att bifogade kopior överensstämmer med de handlingar som ursprungligen ingivits till Patent- och registreringsverket i nedannämnda ansökan.

This is to certify that the annexed is a true copy of the documents as originally filed with the Patent- and Registration Office in connection with the following patent application.

(71) *Sökande* — *Solibro AB, Uppsala SE*
Applicant (s)

(21) *Patentansökningsnummer* — *0400582-3*
Patent application number

(86) *Ingivningsdatum* — *2004-03-05*
Date of filing

Stockholm, 2005-03-15

För Patent- och registreringsverket
For the Patent- and Registration Office

Gunilla Larsson

Avgift
Fee

PATENT- OCH REGISTRERINGSVERKET
SWEDEN

Postadress/Adress
Box 5055
S-102 42 STOCKHOLM

Telefon/Phone
+46 8 782 25 00
Vx 08-782 25 00

Telex
17978
PATOREG S

Telefax
+46 8 666 02 86
08-666 02 86

Ink. t. Patent- och reg.verket
2004 -03- 0 5
Huvudfaxen Kansan

METHOD FOR IN-LINE PROCESS CONTROL OF THE CIGS PROCESS

TECHNICAL FIELD OF THE INVENTION

The Invention relates a method and apparatus for control of the copper indium gallium diselenide (CIGS) solar cell layer fabricated by a co-evaporation deposition process in a process chamber.

Technical background

Solar cells provide a means to produce electric power with minimal environmental impact because it is a renewable technology. In order to become a commercial success the solar cells need to be efficient, to have low cost, to be durable, and not add other environmental problems.

Today's dominant solar cell technology is based on crystalline silicon. It fulfils many of the requirements mentioned above but can not be produced at such low cost that electricity generation in large scale is cost effective. It also requiros relatively large amount of energy in the production, which is an environmental disadvantage.

Solar colls based on thin film technologies have been developed. They offer a potential of substantial cost reductions but have, in general, lower conversion efficiencies and less good durability. A very promising thin film solar cell technology is based on the semiconductor $Cu(In,Ga)Se_2$ (CIGS) which has demonstrated high eificiencies (16,6 % in small protolype modules) and durability in operation. It remains to demonstrate low cost in real production.

DESCRIPTION OF RELATED ART

In Fig. 1 a CIGS solar cell is shown to comprise a CIGS layer 1 on a substrate material 2 such as sheet glass or metal foil, which has been coated with a layer 3 of molybdenum. This layer serves as a back contact of the solar cell. The CIGS growth is followed by the formation of a pn-junction by deposition of a buffer layer 4, typically 50 nm of CdS, a high resistivity thin layer 5 of ZnO (sometimes omitted) and a front contact 6 of a transparent conductive oxide 6. One critical factor for obtaining solar colls with high light to electricity conversion efficiency is the quality of the CIGS material.

US 6,310,281 describes high vacuum co-deposition methods using three or five boats as effusion sources for the elements to be deposited. In the three vapour

source method a strip of Mo-coated substrate material travels in a chamber through the vapor deposition zone. Each point on that material first passes directly over the copper source, thereafter over the gallium source, thereafter over the indium source, and throughout, over the selenium sources.

The respective vapor effusion rates of copper, gallium and indium from the crucibles/boats are controlled in such a fashion that the entrance end of the vapour deposition zone is copper-rich, the middle region of this zone is gallium-rich, and the exit end of the zone is indium-rich. By establishing appropriate effusion rates for copper, gallium and indium the composition of the CIGS film varies along the deposition zone in accordance with the following: (a), within the entrance end of the deposition zone the ratio (Cu)/(Ga+In) is generally about 3.4, and the ratio (Ga)/(Ga+In) is generally about 0.46; (b), within the middle region of the deposition zone the ratio (Cu)/(Ga+In) is generally about 1.9, and the ratio (Ga)/(Ga+In) is generally about 0.43; and (c), within the exit end of the deposition zone the ratio (Cu)/(Ga+In) is generally between 0.8 and 0.92, most preferably, about 0.88, and the ratio (Ga)/(Ga+In) is between generally between 0.25 and 0.3, most preferably 0.275.

The CIGS layer created has an internal make-up or composition of approximately 23.5 atomic percent copper, 19.5 atomic percent indium, 7 atomic percent gallium, and 50 atomic percent selenium.

In accordance with the patent deposition of the various elements is controlled by controlling the vapour effusion rates from nozzles in crucibles and by controlling the temperatures of the molten metals within reservoirs in the crucibles.

The patent does not disclose any means for detecting a transformation of a copper rich CIGS composition into a copper deficient CIGS composition. Neither does the patent describe any means for control of the deposition of the CIGS layer.

The patent also discloses a five stage process according to which each point of the surface of the film in the CIGS chamber encounters , in sequence, a gallium/indium-rich region, a copper-rich region, and finally another indium/gallium-rich region.

US 5,633,033 relates to a method of manufacturing a chalcopyrite film for a solar cell and to a method of monitoring an electrical or optical property of the film in order to determine an end point of the last method step where the electrical or optical

properly of the film demonstrates a specific change. Once the end point is detected the process is stopped.

SUMMARY OF THE INVENTION

One object of the present invention is to provide a control method for accurate control of the co-deposited CIGS layer in an in-line system for fabrication of CIGS solar cells, wherein substrates provided with a molybdenum back contact layer continuously move through a CIGS process chamber.

The control method is based on the fact that several physical and chemical properties of the CIGS material changes abruptly when the CIGS layer is transformed from a Cu-excessive to Cu-deficient composition. In particular the travelling CIGS layer transforms from a two-phase material comprising $Cu(In,Ga)Se_2$ and Cu_xSe into a single phase material comprising $Cu(InGa)Se_2$. The control method is independent of the method used for the manufacture of the CIGS layer. In accordance with the invention the position in the CIGS process chamber at which the transformation takes place, this position being referred to as a reference transition point, is detected. Further, by detecting a shift of the position at which the transformation occurs, this position being referred to as the actual transition point, from the reference transition position and take a corrective action to bring the actual transition point back to the reference transition point it is possible to accurately control the composition of the CIGS layer.

Detection of the transition point is made with at least one sensor adapted to measure a physical parameter representative of the transition. The control action is taken by a controller that receives and processes the sensor signal and provides a corrective signal that adjusts the evaporant fluxes so that the transition point is brought back to its reference position in the process chamber. In the above referenced US patent 5,633,033 the control process is stopped when the transition is detected, while according to the present invention the transition detection process continues all the time and generates control parameters which are used to generate a corrective signal which is used to bring back the transition point to its reference position.

Two sensors forming a sensor pair may be used in order to detect the transition point. The sensors of a pair are arranged at each side of the transition point. There may be two or more sensor pairs arranged over the width of the process chamber in order to detect a respective transition point. A set of evaporation sources is

associated with each sensor pair. Each sensor pair and its associated set of evaporation sources are connected to a respective controller. A controller adjusts any of its associated evaporation sources in order to keep its respective transition point generally still. Control takes place by adjusting the power to the relevant evaporation source heater. The use of several sensor pairs arranged over the width of the process chamber enhances the precision with which the CIGS layer is deposited as seen in a direction over the width of the process chamber.

By providing an x-ray fluorescence composition measuring apparatus, below referred to as an XRF device, downstream the reference transition point it is possible to accurately control the thickness and composition of the CIGS material, thus proving a high output rate of substrates that have accurately controlled composition and thickness.

The method provides a fast feed-back loop in order to achieve good control dynamics.

BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1. is a cross sectional view of a CIGS solar cell

Fig. 2. is a cross sectional view of a CIGS process chamber provided with the control in accordance with the invention

Fig. 3. is a view similar to fig 2 illustrating evaporation rate profiles for the deposited elements

Fig. 4. is a view similar to fig 2 illustrating CIGS film composition vs time/position in the process chamber

Fig. 5. is a view similar to fig 2 illustrating CIGS film emissivity vs time/position

Fig. 6. is a view of the controller,

Fig. 7. is a graph illustrating the sharp transition point in a graph of Cu/Ga+In vs time,

Fig. 8. is a schematic bottom view of the CIGS process chamber and illustrates a second embodiment of the deposition and control systems,

Fig. 9. is a schematic bottom view of the CIGS process chamber and illustrates the use of several sensors at each substrate heater, and

Fig. 10. is a schematic bottom view of the CIGS process chamber and illustrates a second embodiment of the control systems.

DETAILED DESCRIPTION OF EMBODIMENTS

Refer to Fig. 1. The commonly used way of fabricating CIGS solar cells is includes the growth of a CIGS layer 1 on a substrate material 2, such as sheet glass or metal foil, which has been coated with a layer of Mo 3. The Mo layer serves as back contact of the solar cell. The CIGS growth is followed by the formation of a pn-junction by deposition of a buffer layer 4, typically 50 nm of CdS, an optional high resistivity thin layer of ZnO 5 and a front contact of a transparent conductive oxide 6. One critical factor for obtaining solar cells with high light to electricity conversion efficiency is the quality of the CIGS material.

In Fig. 2 a process chamber 7 for the inventive fabrication of a CIGS layer is shown to comprise an inlet 8, an outlet 9, a plurality of substrate heaters 10, a copper evaporation source 11, a gallium evaporation source 12, an indium evaporation source 13, and individual evaporation source heaters 14, 15, 16. Within the process chamber 7 and specifically within a deposition zone DZ the co-evaporation process for establishing the CIGS layer is performed. Thermocouples 14', 15' and 16' are arranged to measure the temperature of the individual evaporation sources. Non-shown temperature controllers are adapted to maintain the temperature of the respective evaporation sources constant. An inventive control system comprises a controller 17 connected to sensors 18, 19 and to the evaporation sources heaters 14-16. An XRF device 20 measures the composition and the thickness of the deposited CIGS layer. Selenium sources 26 are located to give excess selenium at all growth positions in the deposition zone and distribute selenium vapour rather evenly throughout the deposition zone.

In a preferred embodiment of the invention the substrates are glass plates of about 120 cm wide and about 60 cm long, the sensors are thermocouples and the substrate heaters comprise many segments, typically 10 cm wide in the direction of substrate movements. The exact width depends on the overall geometry and size of the process chamber. The substrate heaters may for example be IR lamps. Described in a very short and incomplete way but with the intention to give the reader a general apprehension of the processes taking place in the process chamber the following facts are given: the process chamber is held at vacuum, the glass plates

are at about 500°C when entering the process chamber, the source heaters are heating the crucibles containing the respective elements to temperatures of about 1000 to 1500 °C.

The Mo coated substrates 21 travel with uniform speed through the deposition zone DZ in the direction of arrow 22 on non-shown transfer mechanisms.

The transfer mechanisms are designed so that substrates will flow through the deposition zone edge to edge with a minimal separation in between. In the deposition zone, the evaporation sources are preferably located so that the substrates will see the Cu source before they see the In-source. Ga, which is evaporated in less amount than In (typically high performance CIGS films have Ga/(Ga+In) ratios of 0,15 to 0,40) is preferably located to give higher deposition rates near the entrance of the substrates to the deposition zone than the exit as is illustrated in Fig. 3.

In Fig. 3 the elemental fluxes at different positions in the substrate plane in the direction of substrate movement are shown. In particular the copper evaporation flux is shown at curve 23, the gallium evaporation flux is shown at curve 24 and the indium evaporation flux is shown at curve 25. This way a Ga-gradient which improves solar cell performance is introduced.

As the substrate move through the deposition zone a copper rich layer of low resistivity will be deposited at the entrance end. This layer comprises copper selenide Cu_xSe and $Cu(In,Ga)Se_2$. Further down the line, where the copper flux drops and the indium flux increases, the copper rich layer meets and almost instantly reacts with copper deficient $Cu(In,Ga)Se_2$ by giving away its copper to the copper deficient $Cu(In,Ga)Se_2$ as the substrate moves further down the line. The copper in the copper rich layer will thus be consumed. When the excessive copper in the Cu_xSe has been consumed, which happens at a transition point generally shown at 27, the resulting CIGS layer generally comprise a high resistivity, copper deficient $Cu(In,Ga)Se_2$ layer.

The transition is very sharp and takes place over a short, as seen in the transport direction, clearly defined location or transition zone in the process chamber. In the following this point will be referred to as the reference transition point. For an operator of the in line production line there is not a single instant at which a transition takes place, but transitions take place all the time as the substrate move. The reference transition point will however not move in the deposition zone , provided the

transport speed is uniform and the fluxes are stable therein. In accordance with the invention the reference transition point is used in order to control the formation of the CIGS composition.

Overall, the source arrangement is such that the growth is Cu-excessive in the entrance end of the deposition zone and Cu deficient in the exit end. The fluxes are adjusted to give a final composition of the CIGS film with a Cu/(In+Ga) ratio in the region 0,75 – 0,95, and a Ga/(In+Ga) ratio of about 0,10 to 0,45. In Fig. 7 the final composition of the CIGS film with a Cu/(In+Ga) ratio in the region 0,75 – 0,95 is illustrated. Fig. 7 also illustrates the sharp transition which takes place in the region 0,95 to 1,05.

The amounts of the respective deposited elements are shown in Fig. 4. The composition of the CIGS film at one specific location of the substrate is shown. How the composition at this location changes as the substrate travels through the process chamber is illustrated. Upstream the reference transition point the proportion of Cu to In + Ga is larger than 1 and downstream the transition point it is less than 1.

At each side of the reference transition point, at a distance of 5-30 cm, a respective sensor 18 and 19 is located which monitors a physical property related to the transition, in particular a parameter related to the emissivity, resistivity or heat capacitivity of the CIGS material composition.

If the reference transition point tends to move from its reference location, the shift is detected by the sensors. In principle, the reference transition point may move due either to a change in Cu or a change in (In+Ga) flux. The output signal from the sensors are fed as input signals to the controller in which there is a software program 28 that processes the input signals and provides a corrective output signal by which the evaporant fluxes are adjusted to compensate for the shift and bring the growth conditions back to the reference transition point.

The sensors are adapted to measure a physical parameter representative of the transition of the Cu rich layer into a Cu efficient layer. Exemplary parameters are emissivity, resistivity, heat capacitivity, intensity of light reflected by or transmitted through the deposited CIGS film, and intensity of specular light in relation to intensity of reflected light.

In the following a sensor measuring emissivity will be described in relation to Fig. 5 which in its turn is related to Figures 3 and 4. A substrate that moves with constant speed through the process chamber will cause an output signal from an emission sensor to follow an emissivity curve 29. Since speed is constant there is a linear relation between position (s= v t). The Mo coated substrate entering the process chamber has a low emissivity value because the metal will reflect generally all of the heat radiation from the substrate heaters. As the copper rich layer begins to deposit the emissivity increases and will reach a values that is representative of the copper rich layer. The emissivity will remain on this value until the transition occurs at which instant/position the emissivity changes sharply as is indicated with the broad dotted line 29. At this position a clear change of the emissivity, resistivity and heat capacitivity occurs.

With sensor 18 a high emissivity value is measured and with sensor 19 a low emissivity value is measured. Both sensors are measuring an absolute value of emissivity. Suppose the in line process has been running for a while and that a condition has been attained where the transition point lies still, i.e. it doesn't move. Now, if any of the Cu, Ga or In fluxes starts to vary so that the CIGS film becomes more copper rich this will imply that it will take longer time for the composition to become copper deficient. The transition point will thus shift from the reference position in a direction downwards the process chamber, i.e. to the right in Fig. 5. The output signal from sensor 19 will increase. The emissivity measured by the two sensors will now be high. The controller program will as a result of the processing of the two input signals deliver an output signal to that reduces the copper flux. The copper flow is reduced until the actual transition point has moved back to the reference transition point. If the output signal from sensor 18 decreases the transition point shifts in a direction upstream the reference transition point, I. e. to the left in the drawing, and copper flux must be increased until the actual transition point moves back to the reference position.

The flows from the respective evaporation sources are controlled by adjusting the power supplied to the respective sources. When the power is adjusted, the temperature will be correspondingly adjusted and the thermocouple 14', 15' or 16' will send its temperature reading to the controller.

The controller may for example order that the Cu source shall maintain 1500 °C. The non-shown temperature controller at the Cu source will then adjust the heator 14 until the thermocouple 14' reports a temperature of 1500 °C. If the reference transition point now shifts to the left in Fig. 2, the program in the controller will execute and order an increase of the Cu source temperature to 1502 °C. The temperature controller increases the power to the heater, the temperature rises and this is detected with thermocouple 14' which reports the temperature back to the controller. It is conventional to use temperature sensors at the evaporation sources in order to measure the source temperature. The use of the same sensors in order to control the CIGS deposition process is considered novel.

In the just described scenario it was assumed the shift of the transition point depended on a copper flux that varies. As already mentioned above the transition point may however in principle move due either to a change in Cu or a change in (In+Ga) flux. In order to make sure the right corrective action is taken by the controller additional information is needed. This can simply be the fact that Ga and In sources in general are more stable than a Cu source, and therefore the right corrective action is always assumed to be adjustment of the Cu-flux. In particular the power delivered to the Cu source heater 14 is adjusted. An additional possibility is to use the XRF device 20 provided further down the line. Conventionally an XRF device measures total composition and for thin films of CIGS the total amount of atoms of each deposited element can be determined. Thus a measure of film thickness is obtained.

If the transition point remains still this reflects that the composition of the CIGS layer is correct and that a transition has taken place, but it does not reflect the thickness of the CIGS layer. The thickness could in principle be anyone. Therefore thickness measurements need to be taken and the XRF device is used for this.

From the above it should be clear that the XRF device is primarily used for thickness measurements, even if also compositional data is obtained from XRF, and that the controllor is adapted to control the vapour sources in order to obtain a CIGS layer of correct composition and uniform thickness.

If the transition point moves to the right it would in principle be possible to decrease the In+Ga fluxes in order to obtain a more copper rich deposition, but the XRF device

Ink. t. Patent- och reg.verket
2004 -03- 05
Huvudfaxen Kassan

would then detect that the CIGS film starts to become thinner and would transmit a corresponding signal to the controller. The control program would then find out that the proper corrective action is to increase the copper flux. This gives a slow feedback but adds information on total deposited amounts of each element and not just the relative composition of the constituents. The process window for total deposited amounts, i.e. thickness, is substantially larger than for the composition. Also the process window for Ga/(Ga+In) ratio is relatively large. This means that the slow feedback can be used to adjust for drift in the In and Ga fluxes and the fast feedback for composition control by altering the Cu-flux.

The following section explains why it is possible to detect the transition point by measuring the temperature at the thermocouples. Since the process takes place in vacuum heat is transferred to and from the complete aggregate of substrate and its deposited layers by way of radiation only. Heat transfer by way of conduction takes place within the aggregate. Following a start up phase of the in line system a condition of radiation equilibrium will appear between the substrates and the substrate heaters. In this state the substrate heaters radiate heat, the top surface of the aggregate, that is the surface facing the substrate heaters, will reflect some heat, and the bottom surface of the aggregate, that is the surface comprising the Mo and CIGS layers, will radiate some heat. As seen from the substrate heaters nothing changes as the depositions on the bottom surface progress, the substrate heaters continue to see only the substrate and the Mo layer. The substrate will continue to absorb and reflect the same amounts of heat.

At the bottom surface the emissivity will change when transition takes place. When emissivity is low, the bottom surface will radiate little heat and the aggregate becomes warmer (due to heat conduction within the aggregate) provided the power supplied to the substrate heaters is kept constant. When emissivity is high, the bottom surface will radiate more heat and the aggregate becomes cooler.

Sensor 18, sitting at a location where emissivity is high will measure a certain temperature and sensor 19, sitting after the transition point and thus at a location where emissivity is lower, will measure a temperature which is higher.

Instead of holding the power to the source heaters constant it is possible to control them individually and regulate them so that the temperature of the substrates is held

constant. The heaters at each side of the transition point would then need to be supplied with different powers in order to keep the substrate temperature constant. The power difference will thus indicate that the transition point is present between the substrate heaters in question. Since the transition point is sharp it is possible to use absolute power readings.

As an alternative to use temperature sensors, which are specific embodiments of an emission sensor, in order to detect the transition point it is possible to use optical sensors of the kind described in the above referenced US patent 5,633,033.

Still another alternative is to use a sensor that measures the intensity of light reflected by or transmitted through the deposited CIGS film.

A further alternative is to use an optical device that measures intensity of specular light and intensity of reflected light, the light impinging the top of the deposited CIGS film with an acute angle, one sensor measuring reflected light and another measuring specular light.

Since a sensor takes absolute readings it is, in principle, possible to detect the transition point using one sensor only. It would, however, not be possible to determine in which direction the transition point shifts. By using three, four or more sensors it is possible to determine the direction in which the transition point moves by monitoring and comparing their respective output signals. The use of two or more sensors in order to detect the transition point allows the use of relative readings. The controller and its software would then need to be correspondingly designed.In Fig. 2 additional sensors 30, 31 shown with dashed lines allow for determination of the direction into which a transition points moves. This information is used by the controller to take appropriate corrective actions to bring the transition point back to its reference position. The system of sensors 18, 19, 30, 31 will of course also allow determination of the current position of the transition point.

Fig 8 is a top view of the CIGS process chamber and illustrates a second embodiment of the deposition system. Instead of having a single control system comprising a pair of sensors 18,19, evaporation sources 11, 12, 13, source heaters 14, 15, 16, source temperature sensors 14', 15', 16', an XRF source20, and a controller 17 as shown in Fig. 2 a double control system may be used as shown in Fig.8. Each control system comprises a pair of sensors 18,19, evaporation sources

11, 12, 13, source heaters 14, 15, 16, source temperature sensors 14', 15', 16', an XRF source 20 and a controller 17. The two control systems are arranged side by side. The transit point is thus controlled at two points as seen in a direction over the width of the substrate material. If one looks at Fig. 8 one could say that there are two rows of controls, although this expression is general and non-exact. Each control system is essentially, but not completely, independent of the other. Accordingly control of one transit point is essentially independent of control of the other. As described above a transit point is controlled by controlling the power to the source heaters. By this arrangement a precise control of the deposition of the CIGS film over the width of the substrates is achieved.

A modification of the Fig. 8 embodiment is to use three or more control systems arranged side by side over the width of the substrates and control the transit point at three or more positions.

In Fig. 9 a modification of the invention is shown wherein there is a sensor 18 or 19 at each substrate heater, thus allowing for determination of the transition point at any location within the deposition zone. As shown there are also double rows of control systems like in the Fig. 8 arrangement which will allow for precise control of the deposition of the CIGS film over the width of the substrates wherever transition points are detected. Depending on the implementation of the substrate heaters there may be two or more sensors at each substrate heater in each control system.

A modification of the Fig. 9 embodiment is to use three or more control systems arranged side by side over the width of the substrates and control the transit point at three or more positions.

Fig. 10 discloses a control system wherein sensors are omitted and instead a plurality of XFR devices 20 are arranged downstream the transition point. Like in the Fig. 8 arrangement there may be several rows of XFR devices over the width of the substrate. The XFR devices in each row are connected to a respective controller 17 which is adapted to control the composition as well as thickness of the deposited CIGS layer and adjust the individual vapour sources 11-13 so as to obtain a CIGS layer with the desired composition and with the desired thickness over the width of as well as length of the substrates.

o-0-o

Ink. t. Patent- och reg.verket
2004 -03- 05
Huvudfaxen Kassan

CLAIMS

1. A method for composition control of copper indium gallium diselenide (CIGS) solar cells fabricated by a co-evaporation deposition process in a process chamber, the deposition conditions being such that a deposited Cu-excessive overall composition is transformed into to a Cu-deficient overall composition **characterized by**
   a. performing said co-evaporation process in the process chamber of an in-line, continuous substrate flow production system,
   b. detecting where the transition from copper rich to copper deficient composition occurs by using a physical parameter related to the same transition, said instant referred to as a reference transition point.
   c. detecting a shift of the transition point using the physical parameter, and
   d. adjusting the evaporant fluxes in order to bring the transition point back to the reference transition point.

2. A method in accordance with claim 1, **characterized by** performing said detection at at least one location as seen in a direction over the width of a substrate.

3. A method in accordance with claim 2, wherein a substrate provided with a molybdenum back contact layer moves through the CIGS process chamber **characterized** in that the physical parameter is monitored at two points, one at each side of the position the CIGS layer has in the process chamber at the reference transition point, in order to detect the position at which the transformation occurs, said position referred to as a reference position.

4. A method in accordance with claim 3, wherein heating elements are arranged at each side of the position at which the transition occurs **characterized by** holding the power delivered to the substrate constant and measuring a temperature difference at two adjoining heating elements at the reference position.

5. A method in accordance with claim 3 **characterized by** holding the temperature of the substrate and deposited CIGS film constant by supplying individually

controlled power to the heating elements and measuring a difference in the power delivered at two adjoining heating elements at the reference position.

6. A method in accordance with claim 3, wherein a several pairs of sensors distributed over the width of the process chamber, are used for detection at said two points, **characterized by** assigning each sensor pair a respective set of evaporation sources and adjusting the evaporation flows in each evaporation set individually in order to bring the respective transition points back to their reference transition positions.

7. A method in accordance with any of claims 3-6, wherein a pair of sensors is used for detection at said two points, **characterized by** adjusting the copper flux in each set.

8. A method in accordance with claim 3, **characterized** in that the physical parameter is related to the emissivity of the CIGS layer.

9. A method in accordance with claim 3, **characterized** in that the physical parameter is heat capacitivity or, as is known per se, resisitivity.

10. A method in accordance with claim 3, **characterized** in that the physical parameter relates to intensity of light reflected by or transmitted through the deposited CIGS film.

11. A method in accordance with claim 3, **characterized** in that the physical parameter relates to intensity of specular light in relation to intensity of reflected light.

12. An in-line continuous substrate flow production apparatus for fabrication of copper indium gallium diselenide (CIGS) solar cells comprising a CIGS process chamber (7) in which substrates (2) provided with a molybdenum back contact layer (3) continuously move through a deposition zone (DZ) in the CIGS process chamber, the process chamber comprising a plurality of separated heating elements (10) **characterized by** at least one sensor (18, 19; 30, 31) arranged in deposition zone and connected to a controller, the sensor being adapted to measure a physical parameter related to a transformation of the deposited CIGS film from a Cu-excessive composition to a Cu-deficient composition, said transformation taking place at a reference transition point (27) in the process chamber as the substrate moves through the process chamber, the sensor

being arranged to detect a shift of the actual transition point on the moving substrate from the reference transition point by measuring the physical parameter at the deposited CIGS film at the reference transition point, the controller (17) being adapted to receive as input the sensor output signal and to deliver as output a corrective signal that adjusts the evaporant fluxes so that the actual transition point is brought back to the reference transition point.

13. An in-line production apparatus in accordance with claim 12, **characterized in that** two sensors together forming a sensor pair (18, 19) are arranged at each side of the transition point, that each sensor in the pair is connected to a respective input of the controller, said sensor pair being arranged in a row with the evaporation sources.

14. An in-line production apparatus in accordance with claim 13, wherein a sensor pair is associated with an individual set (11-13) of evaporation sources, **characterized in that** that two sensor pairs (18, 19) are arranged at different locations as seen in a direction over the width of the process chamber, that each sensor pair is connected to a respective controller (17) so as to control each set of evaporation sources individually, and that each sensor pair and its associated set of evaporation sources are arranged in a respective row.

15. An in-line production apparatus in accordance with claim 14, **characterized in that** that additional sensor pairs and associated evaporation sources (11-13) are arranged in a row at a location between said two rows.

16. An in-line production apparatus in accordance with claim x, **characterized in that** in each row on or more additional sensors (30, 31) are connected to an input of the respective controllers (17), the additional sensors being arranged to measure the physical parameter upstream and/or downstream the reference transition point.

17. An in-line production apparatus in accordance with claim 12, **characterized in that** the controller (17) is adapted to change the relative amount of Cu versus In+Ga.

18. An in-line production apparatus in accordance with claim 12, **characterized by** an x-ray fluorescence composition measurement device (20) adapted to

Ink. t. Patent- och reg.verket
2004 -03- 0 5
Huvudfoxen Kassan

measure the total deposited amounts of each element (Cu, Ga, In, Se) and thereby the thickness of the deposited CIGS layer.

19. An in-line production apparatus in accordance with claim x, **characterized in that** the controller (17) is connected to the x-ray fluorescence composition measurement device (20) and is adapted to adjust the total amount of deposited Cu and/or the total amount of deposited Ga+In in order to keep the thickness of the deposited CIGS layer constant.

20. An in-line continuous substrate flow production apparatus for fabrication of copper indium gallium diselenide (CIGS) solar cells comprising a CIGS process chamber (7) in which substrates (2) provided with a molybdenum back contact layer (3) continuously move through a deposition zone (DZ) in the CIGS process chamber, the process chamber comprising a plurality of separated substrate heaters (10), vapour sources (11-13, 26) and vapour source heaters (14, 15, 16) **characterized by** at least two XRF (x-ray fluorescence composition measurement devices) devices (20) arranged over the width of the process chamber as seen in the transport direction of the substrates, said XFR devices adapted to measure the thickness and composition of the deposited CIGS layer, and a controller (17) connected to the XRF-devices and adapted to control at least one of the vapour sources in order to provide deposition of a CIGS layer of uniform composition and uniform thickness.

o-0-o

Ink. t. Patent- och reg.verket
2004 -03- 05
Huvudfaxen Kassan

ABSTRACT

An in-line production apparatus and a method for composition control of copper indium gallium diselenide (CIGS) solar cells fabricated by a co-evaporation deposition process is described. The deposition conditions are so that an deposited Cu-excessive overall composition is transformed into to a Cu-deficient overall composition, the final CIGS film. Substrates with a molybdenum layer move through the CIGS process chamber (7) with constant speed. The transition from copper rich to copper deficient composition on a substrate is detected by using a physical paramater related to the transition. The position at which the transition takes place in the process chamber is referred to as a reference transition point (27). A shift of the transition point is detected by sensors (18, 19) adapted to measure the physical parameter, for example emissivity. The sensors are connected to a controller (17) that in response to a detected shift adjusts the fluxes from the evaporant sources (11, 12, 13) in order to bring the transition point back to the reference transition point. Fig. 2 for publication.

Ink. t. Patent- och reg.verket
2004 -03- 05
Huvudfaxen Kassan

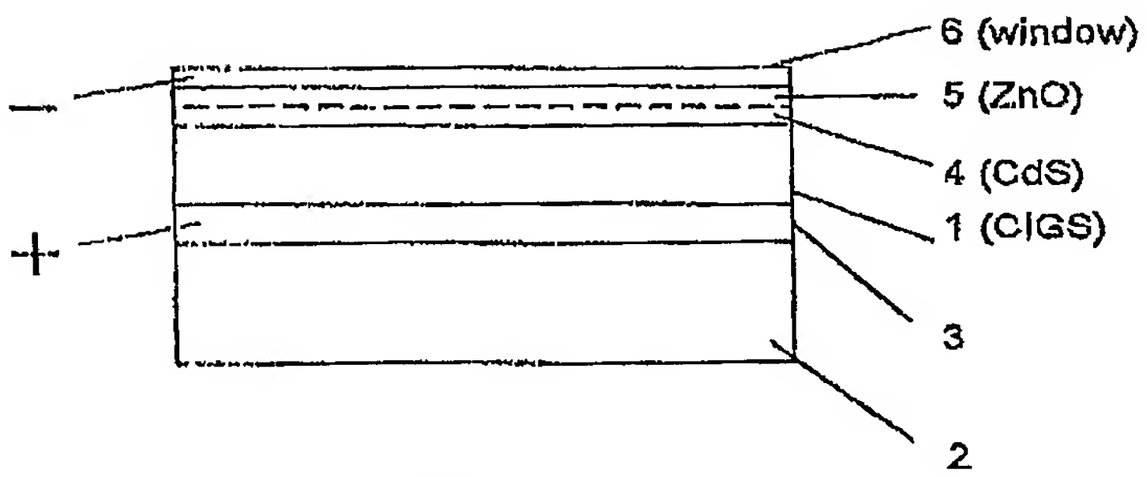

FIG. 1

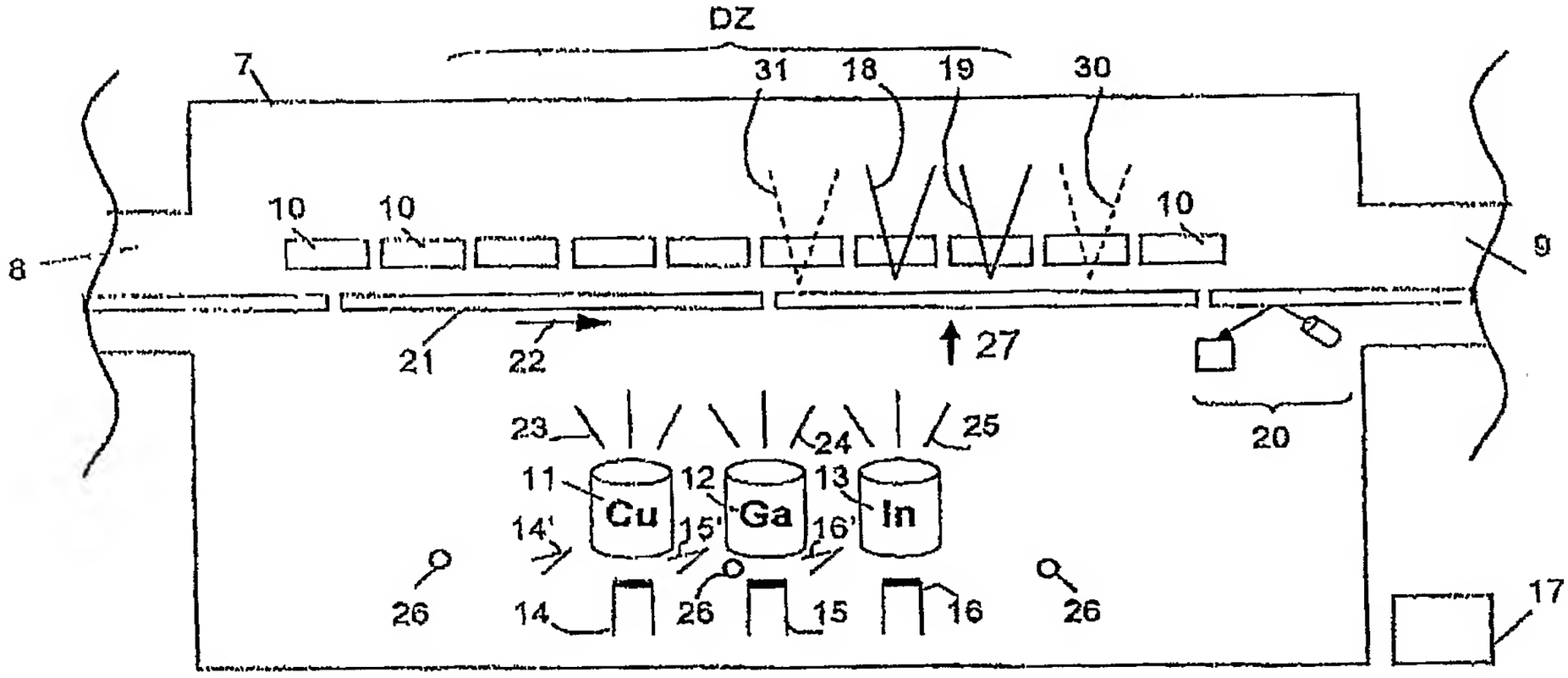

FIG. 2

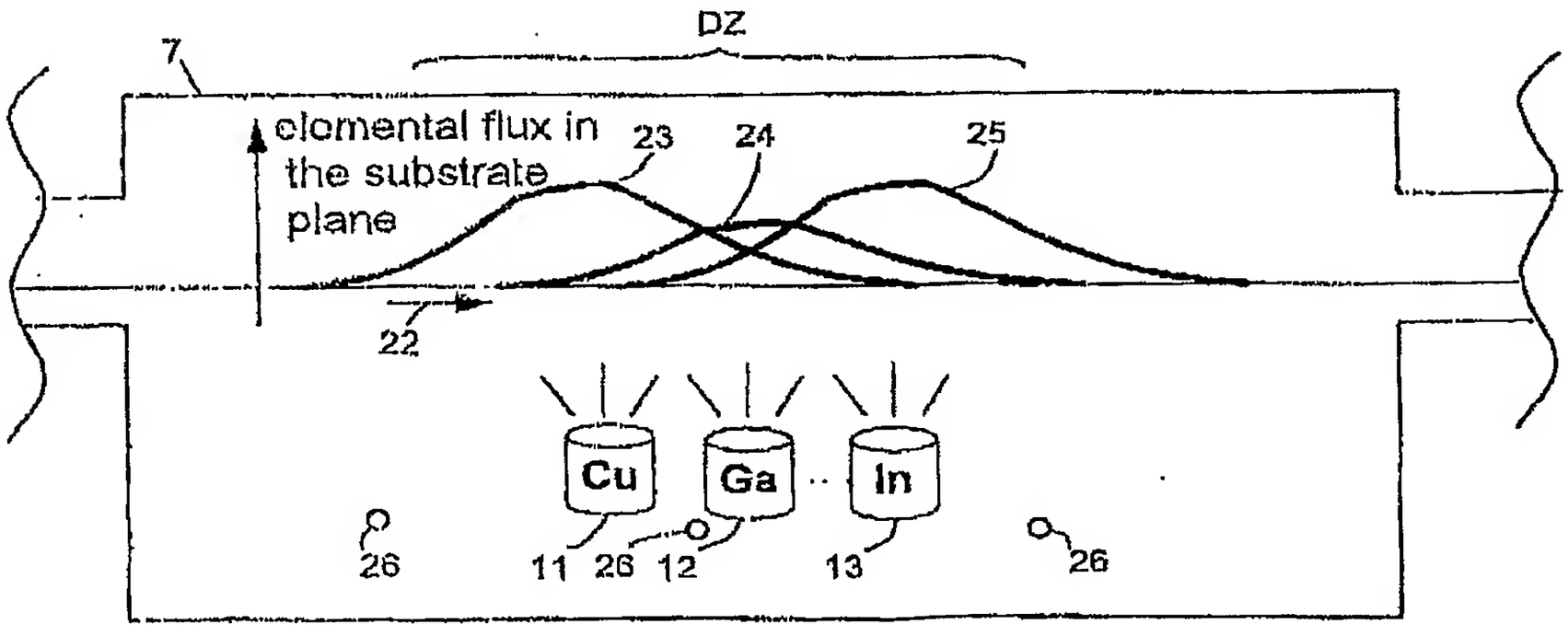

FIG. 3

Ink. t. Patent- och reg.verket
-03- 0 5
Huvudfaxen Kassan

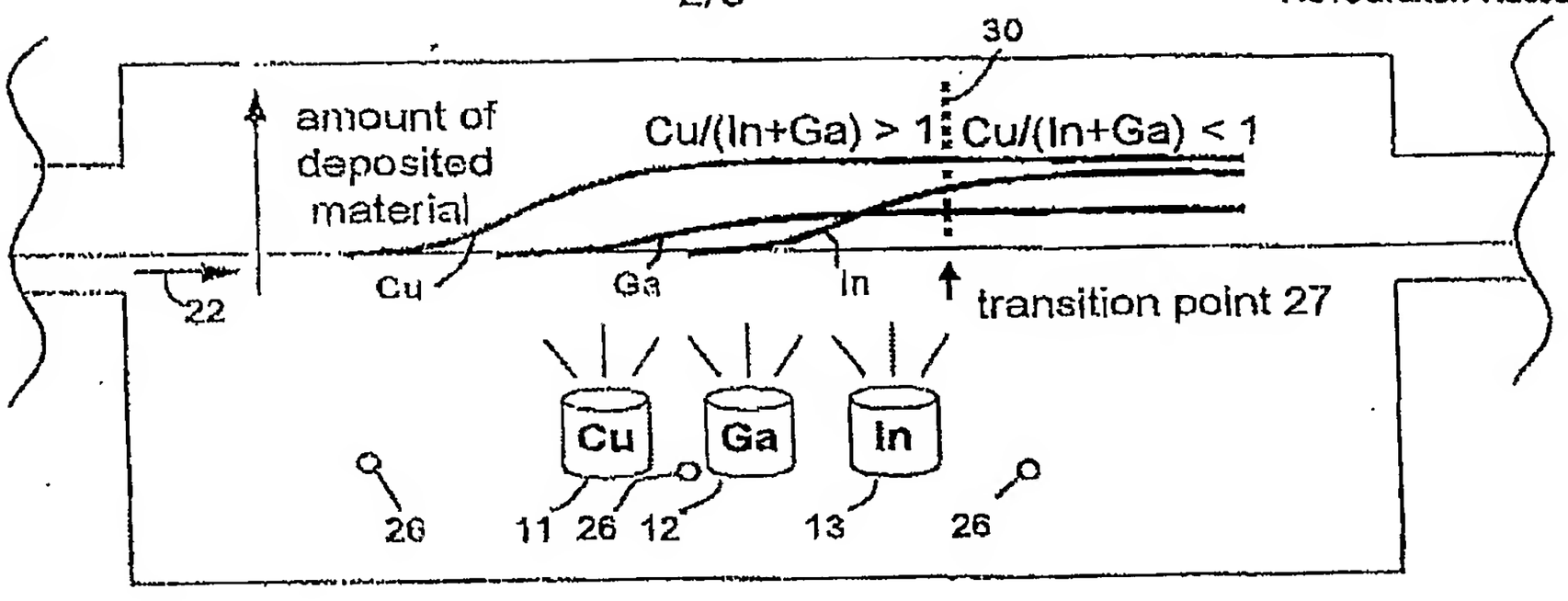

FIG. 4

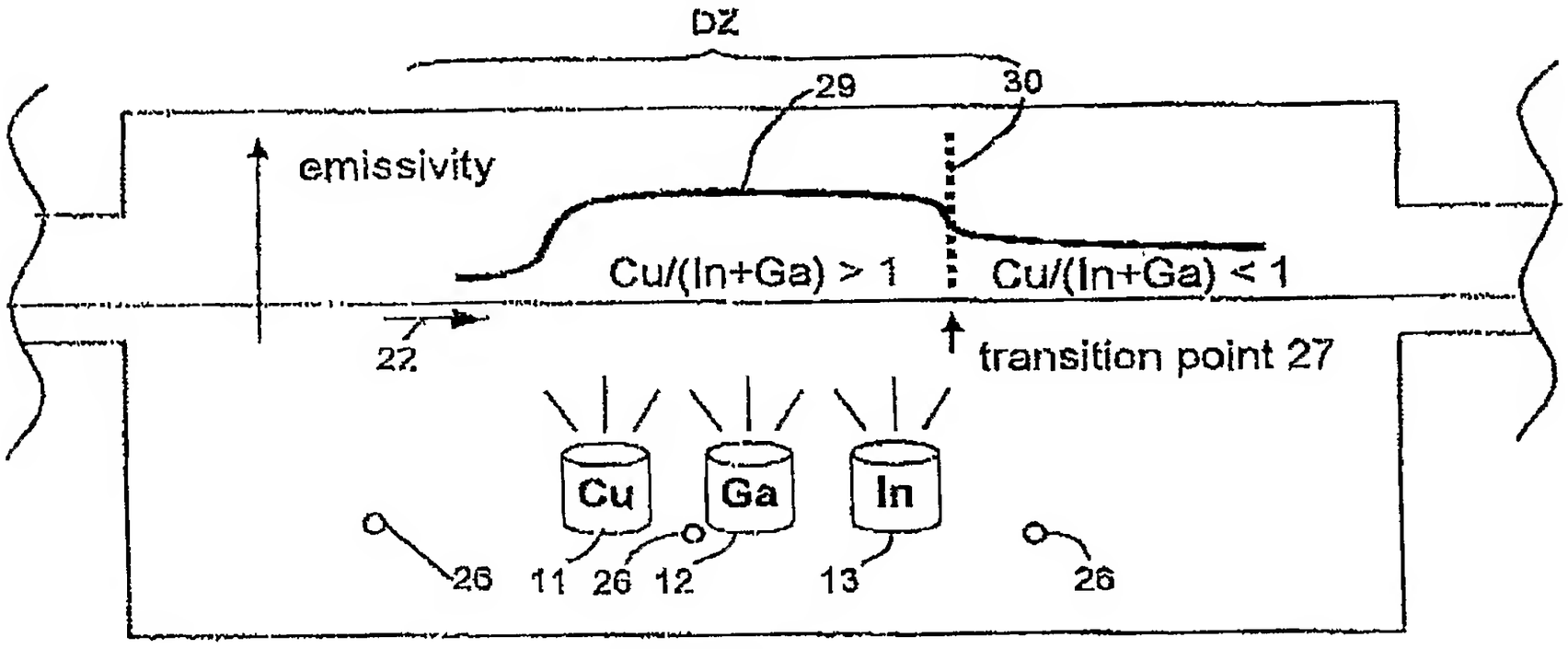

FIG. 5

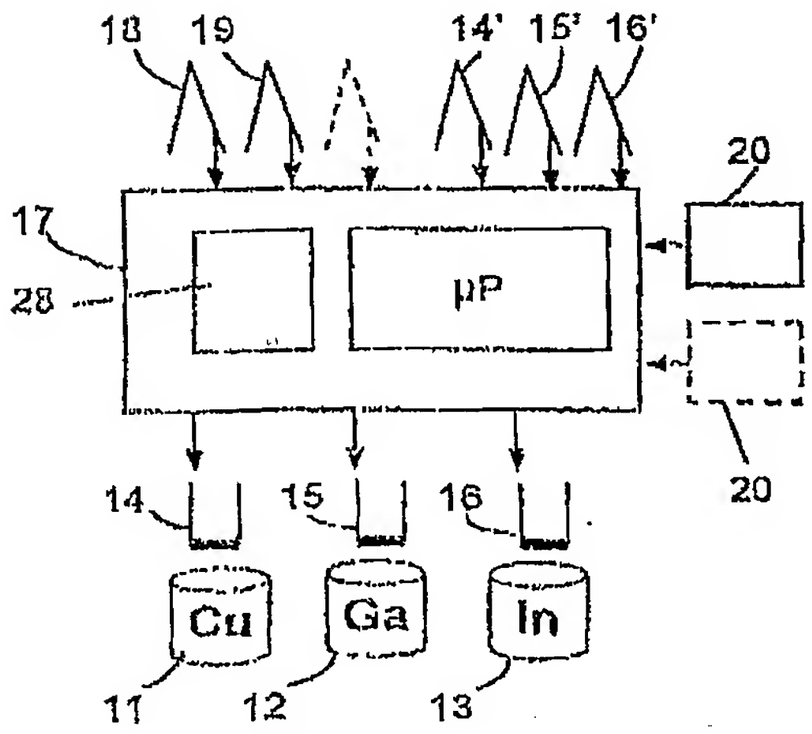

FIG. 6

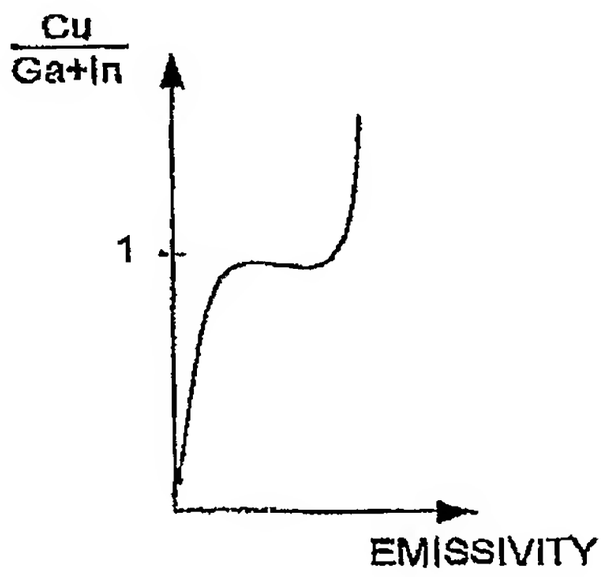

FIG. 7

Ink. t. Patent- och reg.verket
2004 -03- 05
Huvudfaxen Kassan

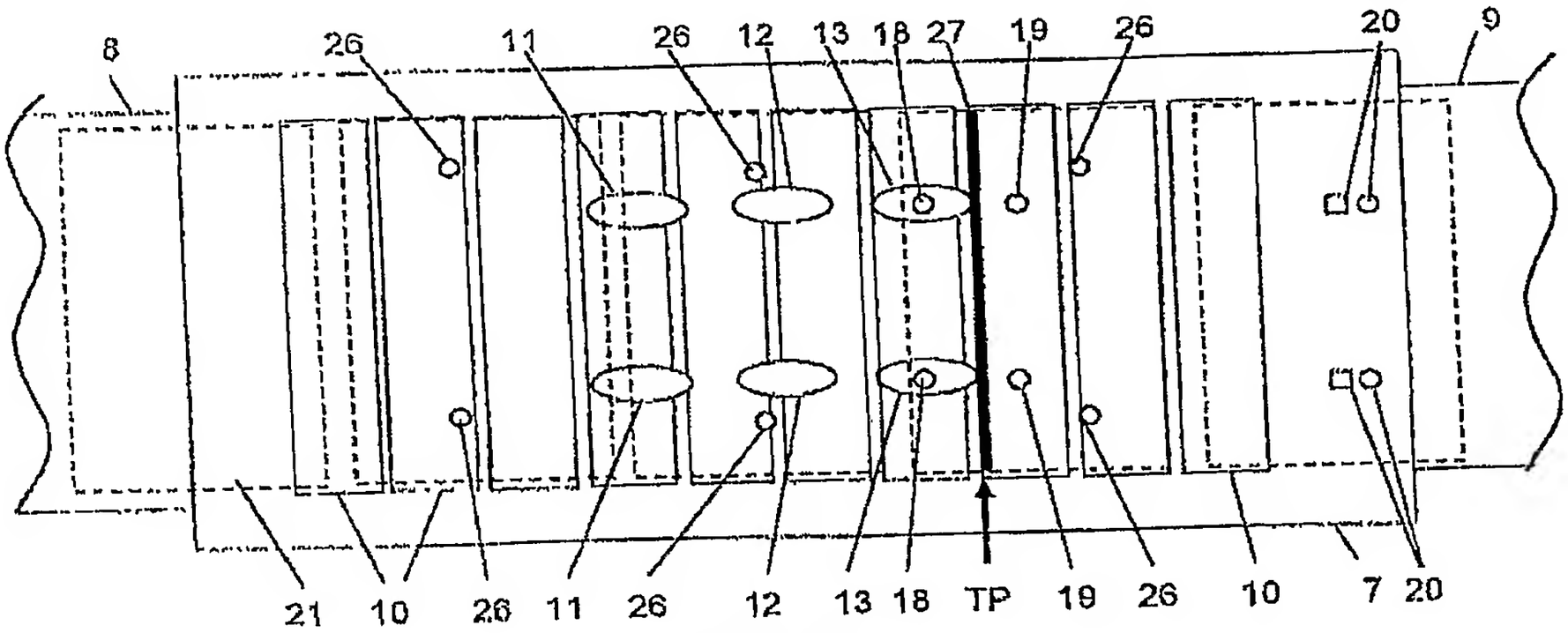

FIG. 8

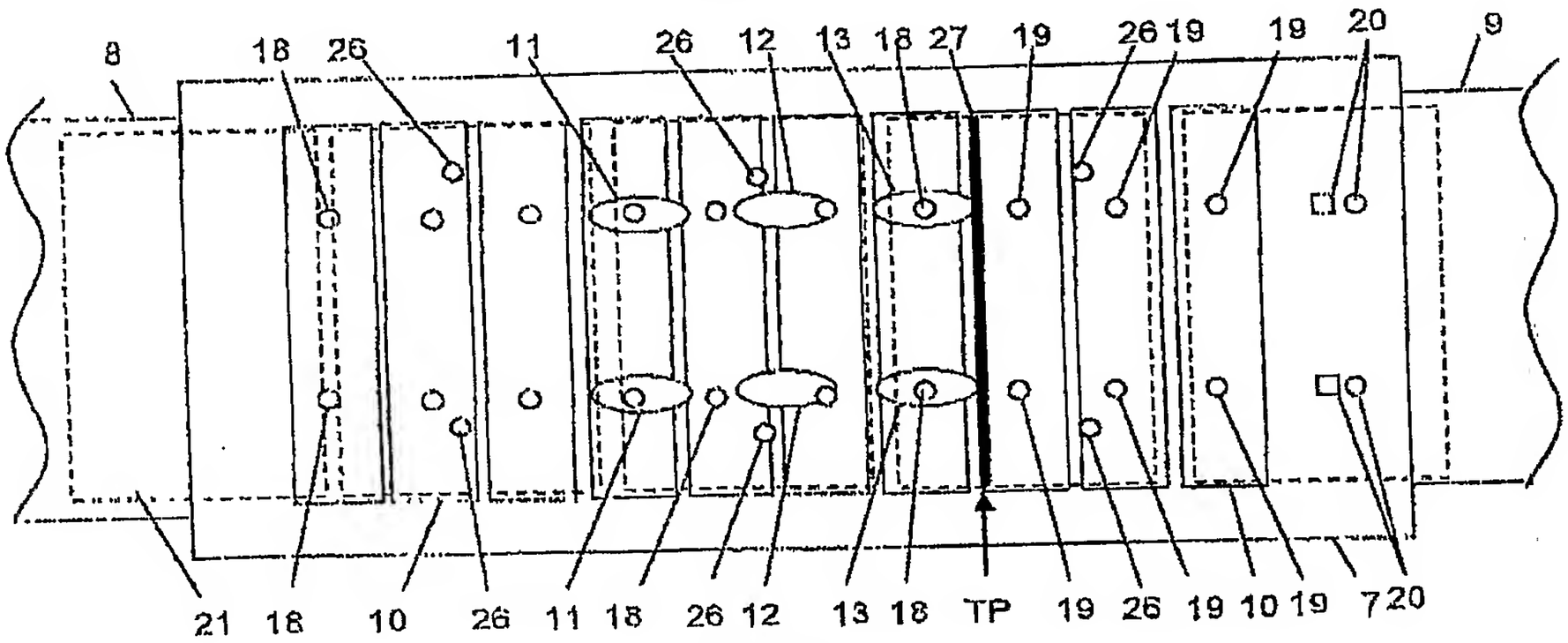

FIG. 9

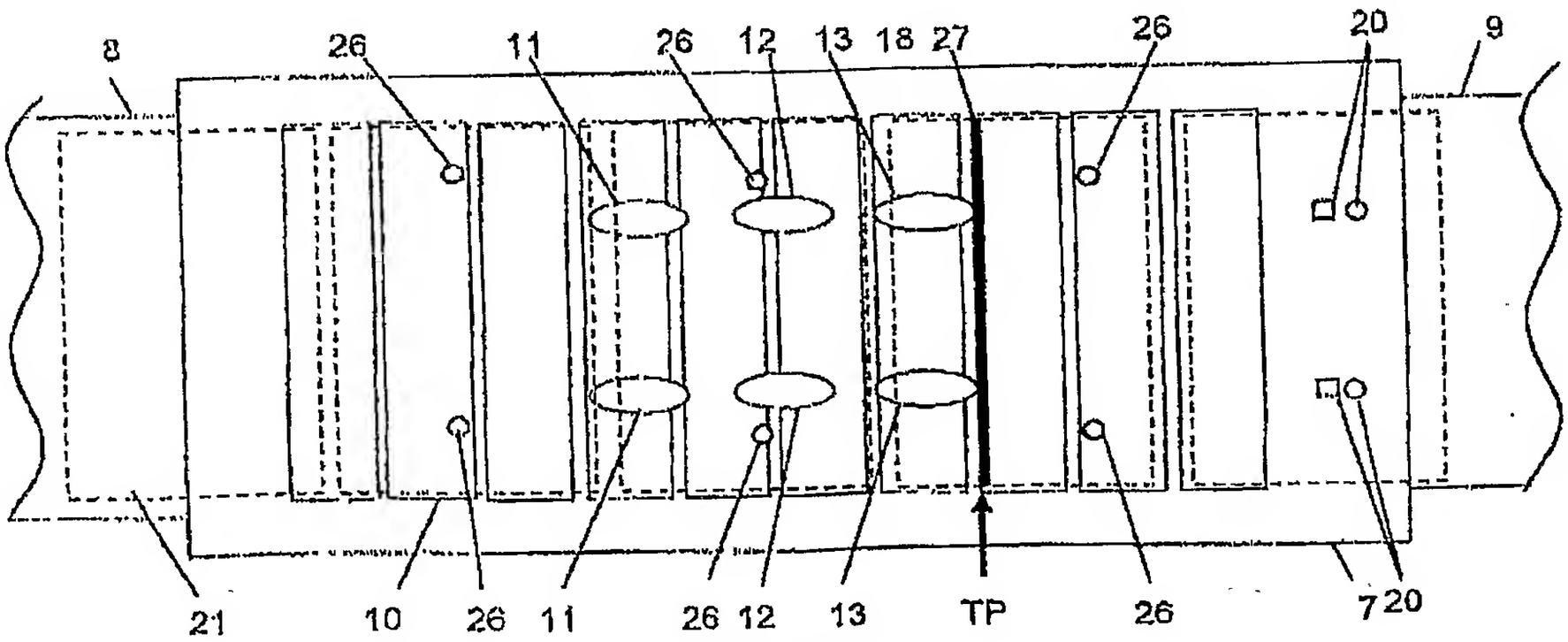

FIG. 10